Preparation and Field-Induced Electrical Properties of Perovskite Relaxor Ferroelectrics

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(111)-oriented and random oriented Pb$_{0.99}$Nb$_{0.02}$ (Zr$_{0.75}$ Sn$_{0.20}$ Ti$_{0.05}$ )O$_3$ ceramics, due to the restriction of breakdown fields (~ 50 kV/cm ) and figure-of-merit (FOM ~ 236) at room temperature (290 K), rather than at its Curie temperature (408 K), was observed in random oriented Pb$_{0.99}$Nb$_{0.02}$ZrO$_3$ (PBZ) thin film, which makes it a promising material for the application to cooling systems near room temperature. The giant ECE as well as high dielectric tunability are attributed to the coexistence of AFE and FE phases and field-induced nano-scaled AFE to FE phase transition.

Keywords: Relaxor ferroelectrics, Dielectric tunability, Electrocaloric, Sol-gel, Field-induced phase transition

1. INTRODUCTION

Dielectric tunable materials have recently received renewed attention due to the potential applications in filters, phase shifters, wireless communications, etc. [1,2]. These applications demand dielectric materials to possess not only the high dielectric tunability, but also the low dielectric loss, high figure-of-merit, and high temperature stability [3,4]. To accomplish these requirements, most research efforts in this area are mainly focused on investigating the titanium-containing perovskite ferroelectric materials such as (Ba,Sr)TiO$_3$ (BST), Ba(Zr,Ti)O$_3$ (BZT), etc. [5,6]. Due to the oxidation state of titanium being easily reduced from Ti$^{4+}$ to Ti$^{3+}$, [7-12] the dielectric tunable properties of these titanium-containing ferroelectrics usually undergo degradation (dielectric loss increasing and figure-of-merit decreasing) at high temperature.

ECE is a change in temperature ($\Delta T$) in a polarizable material by virtue of the change in entropy ($\Delta S$) upon the application or withdrawal of an electric field under adiabatic conditions [13-15]. Simulation results [16] indicate that cooling devices based on large ECE can have much higher coefficient of performance (COP) (> 60% of Carnot efficient) than those (< 20% of Carnot efficient) of mechanical vapor compression cycle cooling devices such as refrigerator and air-conditioner, which generate strong greenhouse gases during their operations. For the development of ECE cooling technologies in the past, the bottleneck existed because only a small $\Delta T$ and $\Delta S$ can be induced in bulk materials, such as only $\Delta T = 2.5$ K and $\Delta S = 0.2$ JK$^{-1}$kg$^{-1}$ at 750 V in Pb$_{2.95}$Nb$_{0.05}$Fe$_{0.03}$TiO$_3$ ceramics, due to the restriction of breakdown fields (~ 50 kV/cm$^{-1}$). By resorting to a thin-film geometry, giant ECE ($\Delta T = 12$ K and $\Delta S = 8$ JK$^{-1}$kg$^{-1}$ at 776 kVcm$^{-1}$) was observed by Mischenko et al. [13] in near antiferroelectric paraelectric phase transition temperature ($T_c = 500$ K).

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has triggered a new wave of interest in the search for new ECE materials, which resulted in significant progress in this field and raised hope for successful development of ECE solid-state cooling units. For example, Saranaya et al. [18] reported a bigger ECE temperature change (ΔT = 31 K) at 413 K and 747 kV/cm in Pb(Mg1/3Nb2/3)0.65Ti0.35O3 thin films deposited by PLD. But the application of cooling devices needs maximum EC effect at or near room temperature.

In this work, (111)-oriented and random oriented nano-scaled antiferroelectric and ferroelectric two-phase coexisting in relaxor Pb0.8Ba0.2ZrO3 thin film were fabricated by a sol-gel method. High temperature stability (η > 75% and FOM > 230 at 560 kV/cm in the range from 300 K to 380 K) was achieved in the (111)-oriented PBZ thin film, making this thin film comparable with those titanium-containing ferroelectric materials. Meanwhile, a giant ECE (ΔT = 45.3 K and AS = 46.9 J K⁻¹ kg⁻¹ at 598 kV cm⁻¹) in the random oriented Pb0.8Ba0.2ZrO3 film at room temperature (290 K), away from its Curie temperature (408 K), was observed.

2. EXPERIMENTS

Pb₀.₈Ba₀.₂ZrO₃ (PBZ) thin films were fabricated by a sol-gel method. Pb(OAc)₂·3H₂O and Ba(OAc)₂ were dissolved in glacial acetic and deionized water. In order to compensate for the Pb loss during sintering, 20% of excess Pb was added. Separately, acetylacetone was added to a mixture of Zr(O(acac))₄ and 2-methoxyethanol, and the resulting solution was stirred for 30 min at room temperature. The Pb/Ba and Zr solutions were then mixed and stirred for 2 h at room temperature. The final concentration of the synthesized PBZ sol was 0.3 M. After aging the sol for 24 h, the PBZ sol was passed through a 0.2 μm filter and spun onto Pt(111)/TiOₓ/SiO₂/Si(100) substrates at 4,000 rpm for 30 s. The substrates were rinsed with acetone and 1-propanol before use. To obtain the (111)-oriented PBZ thin film, each layer was pyrolized at 350 °C for 3 min and then heated at 550 °C for 3 min on hotplates, and finally annealed at 800 °C for 3 min in a tube furnace in air.

The above-mentioned procedure was repeated 8 times to obtain the desired thickness. To obtain the random oriented PBZ thin film, each layer was pyrolized at 350 °C for 3 min and then heated at 550 °C for 5 min on hotplates. After the deposition of 8 layers, the film was annealed in a tube furnace at 750 °C for 30 min in air. To be clear, Fig.1 shows the above preparation process of two different Pb₀.₈Ba₀.₂ZrO₃ thin films. The final thickness of all the films were about 320 nm. Cr/Au top electrodes of 150 μm diameter were evaporated through a patterned photomask. The structure of the PBZ films were monitored by X-ray diffraction (XRD; Bruker-AXS D5005, Siemens, Munich, Germany) on a diffractometer, using Cu Ka radiation (λ=1.5406 Å). The cross-sectional and surface morphologies of the film were examined by scanning electron microscope (SEM; FEI XL30 SFEG, Philips, Eindhoven, The Netherlands). Dielectric permittivity measurements were carried out using an impedance analyzer (Wayne-Kerr Electronics, West Sussex, UK) at V = 100 mV. Electric field dependences of dielectric hysteresis (P-E) loop and leakage current (I(t)) were obtained by means of a ferroelectric tester (RT686A, Radiant Technologies Inc., Albuquerque, NM, USA). The temperature of the sample was controlled via feedback from a thermocouple, accurate to 0.1°C, in contact with the sample.

3. RESULTS AND DISCUSSION

Superlattice reflections with indices (130)/(112) and (014) in XRD patterns indicate the existence of orthorhombic antiferroelectric phase both in the (111)-oriented and random oriented PBZ thin film. The SEM surface images further revealed that the microstructure of the two PBZ thin films were uniform, homogeneous, and crack-free, with average grain size of 20 nm. To further study the morphology and microstructure of the two PBZ thin films in detail, the TEM characterization was carried out.

Numerous dispersed nanocrystals corresponding to those subgrains in the SEM were observed in the TEM bright field images. Inside of some nanocrystals, lamellar nanodomains with about 2 nm of width and lamellar nanodomains with about 1 nm of width were clearly visible. The latter can be attributed to the antiferroelectric domains with 1 nm of width close to its cell parameters, which is consistent with the report by Viehland in PZT. [19] According to the refined α values (90.9463°) of the RFE (rhombohedral ferroelectric) phase and the feature of the SAED patterns in the two PBZ thin films, lamellar nanodomains with about 2 nm of width probably are due to the existence of 180° ferroelectric domains.

Typical characteristic of ferroelectric relaxor was observed around the dielectric permittivity peak of the temperature dependences of dielectric permittivity (ε) of the two PBZ thin films. In contrast, the same character was detected in Pb₀.₈−xBaₓZrO₃ bulk ceramics with Ba⁺⁺ substitution at x < 0.3. [20] This difference can be attributed to the mismatch effect between the film and the substrate and to the smaller grain size. Although the dielectric permittivity (see Table 1) was higher compared with those found in PZT-based compositions, it was rather lower than that obtained in the corresponding sintered bulk PBZ ceramics with the same composition, which may most probably be due to the limited film thickness. Likewise, the maximum dielectric permittivities were observed at 433 K (Tₘ at 100 Hz) in (111)-oriented thin film and at 408 K (Tₘ) in random oriented thin film, rather than at 425 K as reported with PBZ bulk material. The antiferroelectric to ferroelectric (AFE-FE) phase transition in the (111)-oriented thin film was detected at 354 K, which was also observed on the P-T (polarization vs temperature) curve plotted from the P-E (polarization vs electric field) loops at 10 kHz and 156 kV/cm. In contrast, the AFE-FE phase transition in the random oriented thin film was not obviously detected.

Dielectric tunability (η) and figure-of-merit (FOM) of the (111)-oriented PBZ thin film at 10 kHz at room temperature can be defined as follows:

![Figure 1. Fabrication process of the (111)-oriented and random oriented Pb₀.₈Ba₀.₂ZrO₃ thin film.](image-url)
In order to elucidate the giant ECE in the random oriented PbZ thin film, the pyroelectric coefficients $\varepsilon/(\varepsilon/T)$, at selected electric fields were plotted. With the increase of the electric field, the $\varepsilon/(\varepsilon/T)$, at around the temperature of the peak first increased and reached a maximum at 210 kV/cm$^{-1}$, and then decreased. Likewise, the $\varepsilon/(\varepsilon/T)$, near and between the temperature of the twin-peak first increased and reached a maximum at 100 kV/cm$^{-1}$, and then decreased.

To get an insight into this phenomenon, P-E loops under different electric fields and the dc electric field dependence of the dielectric constant, $\varepsilon$, were investigated at 293 K and 403 K. Double P-E loops were visible at 293 K when the electric field was lower than 210 kV/cm$^{-1}$, indicating that an electric field induced AFE-FE phase transition was taking place. Typical ferroelectric P-E loops were obtained when the electric field was higher than 210 kV/cm$^{-1}$. In contrast, only ferroelectric P-E loops were obtained at 403 K under all electric fields. A peak in the curve of $\varepsilon(E)$ was observed at 293 K, which further revealed the existence of the electric field induced AFE-FE phase transition. No peak was detected in the curve of $\varepsilon(E)$ at 403 K. In summary, it can be inferred that the giant EC at room temperature for PbZ thin film may be caused by the electric field-induced AFE-FE phase transition, which could induce new ways to enhance the electrocaloric efficiency by virtue of the noncollinearity between the electric field and the polarization. It is well known that for second order phase transition or higher order phase transition, the entropy change $\Delta S$ is normally smaller than first order phase transition. Bhadra et al. [21] carried out a high temperature X-ray study of structure phase transitions in Pb$_{1-x}$Ba$_x$ZrO$_3$ powders and confirmed the first order nature of the A$_c$ to F$_c$ transition. The A$_c$ to F$_c$ transition is similar to the austenite (A) to martensite (M) transition in some alloys, and large $\Delta S$ can be caused during the transition. Previous work [22,23] pointed out that latent heat (or $\Delta S$) from the field-induced phase transition can significantly contribute to the ECE below the depolarization temperature $T_{dp}$. Therefore, the giant ECE at room temperature as well as the high dielectric tunability for PbZ thin film can be attributed to the contribution of the electric field inducing A$_c$ to FR transition [24,25].

4. CONCLUSIONS

(111)-oriented and random oriented nano-scaled antiferroelectric and ferroelectric phases coexisting relaxor Pb$_{0.8}$Ba$_{0.2}$ZrO$_3$ thin film were successfully prepared by a sol-gel method. A high dielectric tunability ($\eta$ ~ 75%), figure-of-merit ($FOM$ ~ 236), temperature stability ($\eta$ > 75% and $FOM$ > 230 at 560 kV/cm in the range from 300 K to 380 K), and high dielectric strength (leakage current < 1 nA at 598 kV/cm) were observed in the (111)-oriented PbZ thin film, which make it a promising material for applications of tunable devices. A giant ECE ($\Delta T = 45.3$ K and $\Delta S = 46.9$ JK$^{-1}$ at 598 kV/cm$^{-1}$) at room temperature (290 K), rather than at the Curie temperature (408 K), was obtained in the random oriented Pb$_{0.8}$Ba$_{0.2}$ZrO$_3$ thin film. This makes it usable as a promising material for applications in cooling systems near room temperature. Field-induced, nano-scaled antiferroelectric to ferroelectric phase transition played a key role in the dramatic EC effect.

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REFERENCES


